



MSB30KH

3.0A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER

Product Summary (@TA = +25°C)

V _{RRM} (V)	I _O (A)	V _F (V)	I _R (μ A)
800	3.0	1.1	5

Description and Applications

Suitable for AC to DC bridge full wave rectification for SMPS, LED lighting, adapter, battery charger, home appliances, office equipment, and telecommunication applications.

Features and Benefits

- Glass Passivated Die Construction
- Compact, Thin Profile Package Design
- Reliable Robust Construction
- Ideal for SMT Manufacturing
- Rated at 1000V PRV
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

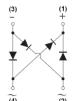
- Case: MSBL
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208@3
- Polarity: As Marked on Body
- Weight: 0.216 grams (Approximate)



Top View



Pin Diagram



Internal Schematic

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
MSB30KH-13	Commercial	MSBL	2500/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



MB30KH = Product Type Marking Code

Oli = Manufacturers' Code Marking

YWW = Date Code Marking

Y = Last Digit of Year (ex: 6 = 2016)

WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic		Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		800	V
RMS Reverse Voltage	V _{R(RMS)}	560	V
Average Rectified Output Current @ T _C = +110°C	Io	3.0	Α
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load		110	Α
Non-Repetitive Peak Forward Surge Current, 1.0ms Single Half Sine-Wave Superimposed on Rated Load		220	Α
I ² t Rating for Fusing (1ms < t < 8.3ms)		50.21	A ² S

Thermal Characteristics

Characteristic		Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 5) (per element)	R _{θJA}	29	°C/W
Typical Thermal Resistance, Junction to Case	R _{0JC}	11	°C/W
Typical Thermal Resistance, Junction to Lead	$R_{\theta JL}$	12	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	1000	_		V	$I_R = 5\mu A$
		1	0.87	1.02	V	I _F = 1.5A, T _A = +25°C
Forward Voltage (per element)	VF	_	0.75	_		I _F = 1.5A, T _A = +125°C
Toward voitage (per element)		_	0.93	1.1		$I_F = 3.0A, T_A = +25$ °C
		1	0.82			$I_F = 3.0A, T_A = +125$ °C
Lookaga Current (Note 6) (nor element)		_	0.4	5	I IIA	$V_R = 800V, T_A = +25^{\circ}C$
Leakage Current (Note 6) (per element)	I _R	1	60	500		$V_R = 800V, T_A = +125$ °C
Total Capacitance (Note 7)	C _T		45	_	pF	$V_R = 4V$, $f = 1.0MHz$

Notes:

- 5. Device mounted on Unit mounted on 15mm*15mm*1.6mm AL pad attach 50mm*50mm*1mm copper plate heatsink.
- 6. Short duration pulse test used to minimize self-heating effect.
- 7. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.



FIG.1- FORWARD CURRENT DERATING CURVE

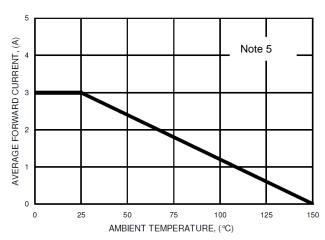


FIG.2- MAXIMUM NON-REPETITIVE SURGE CURRENT

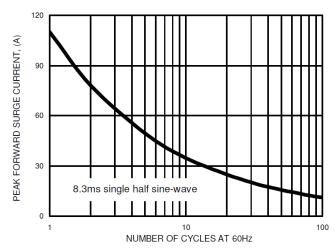


FIG.3- TYPICAL FORWORD CHARACTERISTICS

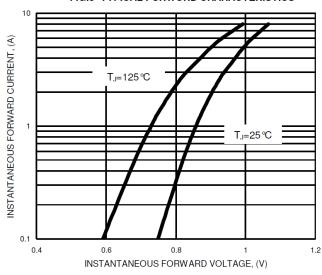


FIG.4- TYPICAL TOTAL CAPACITANCE

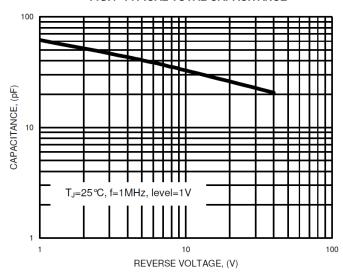


FIG.5- TYPICAL REVERSE CHARACTERISTICS

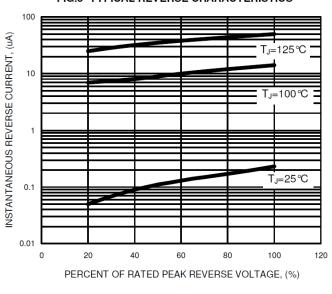
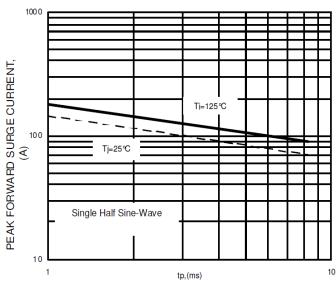


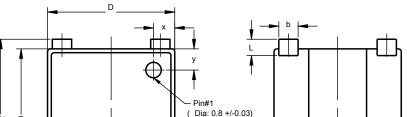
FIG.6- NON-REPETITIVE SURGE CURRENT

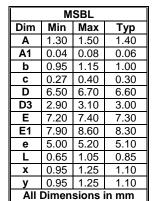


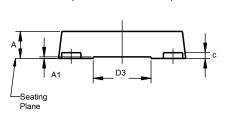


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.





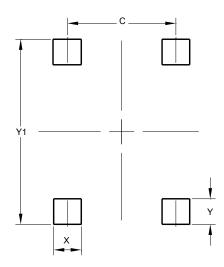


Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

MSBL

MSBL



Dimensions	Value (in mm)			
С	5.10			
Х	1.30			
Y	1.20			
Y1	8.70			



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